ATA2526

Low-voltage IR Receiver ASSP

DATASHEET

Features

Atmel

- No external components except PIN diode
- Supply-voltage range: 2.7V to 5.5V
- High sensitivity due to automatic sensitivity adaption (AGC) and automatic strong signal adaption (ATC)
- Automatic supply voltage adaptation
- High immunity against disturbances from daylight and lamps
- Small size and innovative pad layout
- Available for carrier frequencies between 33kHz to 40kHz and 56kHz; adjusted by zener diode fusing ±2.5%
- TTL and CMOS compatible

Applications

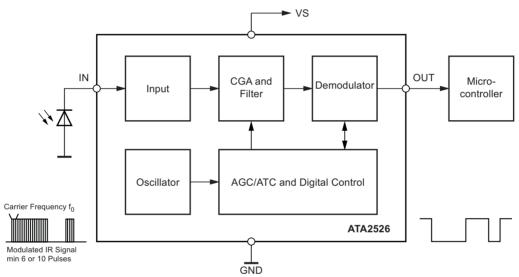
- Home entertainment applications
- Home appliances
- Remote control equipment

1. Description

The Atmel[®] IC ATA2526 is a complete IR receiver for data communication that has been developed and optimized for use in carrier-frequency-modulated transmission applications. The IC combines small size with high sensitivity suppression of noise as caused by daylight and lamps. An innovative and patented pad layout offers unique flexibility for IR receiver module assembly. The Atmel ATA2526 is available with standard frequencies (33, 36, 37, 38, 40, 56kHz) and 3 different noise suppression regulation types (standard, lamp, short burst), thus covering the requirements of different high-volume remote control solutions (please refer to selection guide available for Atmel ATA2525/ATA2526). The Atmel ATA2526 operates in a supply voltage range of 2.7V to 5.5V.

The function of the Atmel ATA2526 can be described using the block diagram of Figure 1-1. The input stage has two main functions. First it provides a suitable bias voltage for the PIN diode. Secondly the pulsed photo-current signals are transformed into a voltage by a special circuit which is optimized for low noise applications. After amplification by a controlled gain amplifier (CGA) the signals have to pass a tuned integrated narrow bandpass filter with a center frequency f_0 which is equivalent to the chosen carrier frequency of the input signal. The demodulator is used first to convert the input burst signal to a digital envelope output pulse and to evaluate the signal information quality, i.e., unwanted pulses will be suppressed at the output pin. This is done by means of an integrated dynamic feedback circuit which varies the gain as a function of the present environmental conditions (ambient light, modulated lamps etc.). Other features can be used to adapt the device to the individual application to ensure best transmission quality.

Figure 1-1. Block Diagram





2. Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameter	Symbol	Value	Unit
Supply voltage	Vs	–0.3 to +6	V
Supply current	۱ _s	3	mA
Input voltage	V _{IN}	–0.3 to $V_{\rm S}$	V
Input DC current at V _S = 5V	I _{IN}	0.75	mA
Output voltage	Vo	–0.3 to $V_{\rm S}$	V
Output current	Ι _Ο	10	mA
Operating temperature	T _{amb}	–25 to +85	°C
Storage temperature	T _{stg}	-40 to +125	°C
Power dissipation at T _{amb} = 25°C	P _{tot}	30	mW

3. Electrical Characteristics, 3-V Operation

 T_{amb} = -25°C to +85°C, V_S = 2.7V to 3.3V unless otherwise specified.

No.	Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit	Type*
1	Supply							
1.1	Supply-voltage range		Vs	2.7	3.0	3.3	V	С
1.2	Supply current	I _{IN} =0	ا _s	0.7	0.9	1.3	mA	В
2	Output							
2.1	Internal pull-up resistor	T _{amb} = 25°C see Figure 5-10 on page 9	R _{PU}		40		kΩ	A
2.2	Output voltage low	$R_2 = 1.4k\Omega$ see Figure 5-10 on page 9	V _{OL}			250	mV	В
2.3	Output voltage high		V _{OH}	$V_{\rm S} - 0.25$		Vs	V	В
2.4	Output current clamping	R ₂ = 0 see Figure 5-10 on page 9	I _{OCL}		8		mA	В
3	Input							
3.1	Input DC current	V _{IN} = 0 see Figure 5-10 on page 9	I _{IN_DCMAX}	-150			μA	С
3.2	Input DC current see Figure 5-3 on page 6	$V_{IN} = 0; V_S = 3V$ $T_{amb} = 25^{\circ}C$	I _{IN_DCMAX}		-350		μA	В
3.3	Minimum detection threshold current see Figure 5-1 on page 6	Test signal: see Figure 5-9 on page 9 $V_S = 3V$	I _{Eemin}		-800		рА	В
3.4	Minimum detection threshold current with AC current disturbance IIN_AC100 = 3µA at 100Hz	$T_{amb} = 25^{\circ}C, I_{ N_DC} = 1\muA$ square pp burst N = 16 f = f ₀ ; t _{PER} = 10ms see Figure 5-8 on page 8 BER = 50 ⁽¹⁾	I _{Eemin}		-1600		рА	С

*) Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. BER = bit error rate; e.g., BER = 5% means that with P = 20 at the input pin 19...21 pulses can appear at the pin OUT

2. After transformation of input current into voltage

3. Electrical Characteristics, 3-V Operation (Continued)

 T_{amb} = -25°C to +85°C, V_S = 2.7V to 3.3V unless otherwise specified.

No.	Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit	Type*
3.5	Maximum detection threshold current with V _{IN} > 0V	Test signal: see Figure 5-9 on page 9 $V_S = 3V$, $T_{amb} = 25^{\circ}C$ $I_{IN_DC} = 1\mu A$ square pp burst N = 16 $f = f_0$; $t_{PER} = 10ms$ see Figure 5-8 on page 8 BER = 5% ⁽¹⁾	I _{Eemax}	-200			μA	D
4	Controlled Amplifier and Filter							
4.1	Maximum value of variable gain (CGA)	$V_{\rm S}$ = 3V, $T_{\rm amb}$ = 25°C	G _{VARMAX}		50		dB	D
4.2	Minimum value of variable gain (CGA)	$V_{\rm S}$ = 3V, $T_{\rm amb}$ = 25°C	G _{VARMIN}		-6		dB	D
4.3	Total internal amplification ⁽²⁾	$V_{\rm S}$ = 3V, $T_{\rm amb}$ = 25°C	G _{MAX}		72		dB	D
4.4	Center frequency fusing accuracy of bandpass	$V_{\rm S}$ = 3V, $T_{\rm amb}$ = 25°C	f _{03V_FUSE}	-2.5	f ₀	+2.5	%	А
4.5	Overall accuracy center frequency of bandpass		f _{03V}	-5.5	f ₀	+3.5	%	С
4.6	Overall accuracy center frequency of bandpass	T _{amb} = 0 to 70°C	f _{03V}	-4.5	f ₀	+3.0	%	С
4.7	BPF bandwidth	–3dB; f ₀ = 38kHz; see Figure 5-7 on page 8	В		3.8		kHz	С

*) Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. BER = bit error rate; e.g., BER = 5% means that with P = 20 at the input pin 19...21 pulses can appear at the pin OUT

2. After transformation of input current into voltage

4. Electrical Characteristics, 5-V Operation

 T_{amb} = -25°C to +85°C, V_S = 4.5V to 5.5V unless otherwise specified.

No.	Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit	Туре*
5	Supply							
5.1	Supply-voltage range		V _S	4.5	5.0	5.5	V	С
5.2	Supply current	I _{IN} =0	ا _S	0.9	1.2	1.6	mA	В
6	Output							
6.1	Internal pull-up resistor	T _{amb} = 25°C see Figure 5-10 on page 9	R _{PU}		40		kΩ	А
6.2	Output voltage low	$R_2 = 2.4k\Omega$ see Figure 5-10 on page 9	V _{OL}			250	mV	В
6.3	Output voltage high		V _{OH}	V _S -0.25		Vs	V	В
6.4	Output current clamping	R ₂ = 0 see Figure 5-10 on page 9	I _{OCL}		8		mA	В

*) Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. BER = bit error rate; e.g., BER = 5% means that with P = 20 at the input pin 19...21 pulses can appear at the pin OUT

2. After transformation of input current into voltage



4. Electrical Characteristics, 5-V Operation (Continued)

 T_{amb} = -25°C to +85°C, V_S = 4.5V to 5.5V unless otherwise specified.

No.	Parameters	Test Conditions	Symbol	Min.	Тур.	Max.	Unit	Туре*
7	Input							
7.1	Input DC current	V _{IN} = 0 see Figure 5-10 on page 9	I _{IN_DCMAX}	-400			μA	С
7.2	Input DC current see Figure 5-4 on page 7	$V_{IN} = 0; V_S = 5V$ $T_{amb} = 25^{\circ}C$	I _{IN_DCMAX}		-700		μA	В
7.3	Minimum detection threshold current see Figure 5-2 on page 6	Test signal: see Figure 5-9 on page 9 $V_s = 5V$	I _{Eemin}		-1000		pА	В
7.4	Minimum detection threshold current with AC current disturbance IIN_AC100 = 3µA at 100Hz	$T_{amb} = 25^{\circ}C$ $I_{IN_DC} = 1\mu A$ square pp burst N = 16 f = f_0; t_{PER} = 10ms see Figure 5-8 on page 8 BER = 50 ⁽¹⁾	I _{Eemin}		-2500		pА	С
7.5	Maximum detection threshold current with V _{IN} > 0V	Test signal: see Figure 5-9 on page 9 $V_S = 5V$, $T_{amb} = 25^{\circ}C$ $I_{IN_DC} = 1\mu A$ square pp burst N = 16 $f = f_0$; $t_{PER} = 10ms$ see Figure 5-8 on page 8 BER = 5% ⁽¹⁾	I _{Eemax}	-500			μA	D
8	Controlled Amplifier and Filte	er	1		1			I
8.1	Maximum value of variable gain (CGA)	$V_{\rm S}$ = 5V, $T_{\rm amb}$ = 25°C	G _{VARMAX}		50		dB	D
8.2	Minimum value of variable gain (CGA)	V _S = 5V, T _{amb} = 25°C	G _{VARMIN}		-6		dB	D
8.3	Total internal amplification ⁽²⁾	$V_{\rm S}$ = 5V, $T_{\rm amb}$ = 25°C	G _{MAX}		72		dB	D
8.4	Resulting center frequency fusing accuracy	f_0 fused at V _S = 3V V _S = 5V, T _{amb} = 25°C	f _{05V}		f _{03V-FUSE} + 0.5		%	С

*) Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. BER = bit error rate; e.g., BER = 5% means that with P = 20 at the input pin 19...21 pulses can appear at the pin OUT
2. After transformation of input current into voltage

4.1 Reliability

Electrical qualification (1000h at 150°C) in molded SO8 plastic package

5. Typical Electrical Curves at T_{amb} = 25°C

Figure 5-1. I_{Eemin} versus $I_{\text{IN}_{DC}}$, V_{S} = 3V

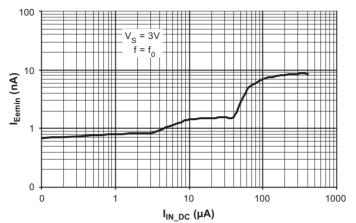


Figure 5-2. I_{Eemin} versus $I_{\text{IN}_{\text{DC}}}$, V_{S} = 5V

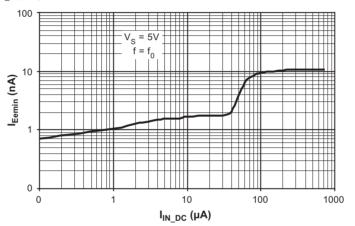


Figure 5-3. V_{IN} versus I_{IN_DC} , $V_S = 3V$

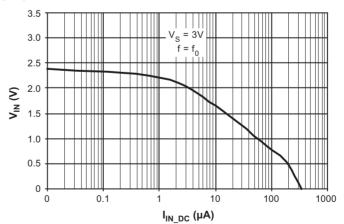




Figure 5-4. V_{IN} versus $I_{IN_{DC}}$, $V_{S} = 5V$

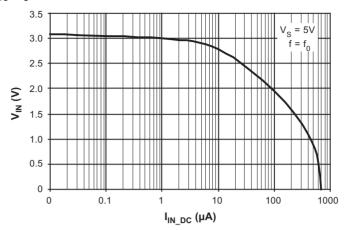


Figure 5-5. Data Transmission Rate, $V_s = 3V$

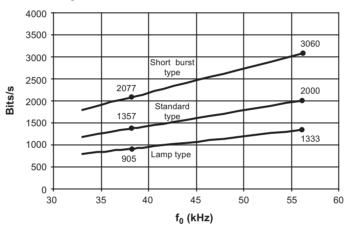
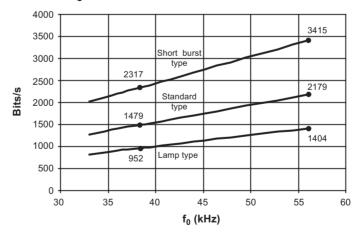
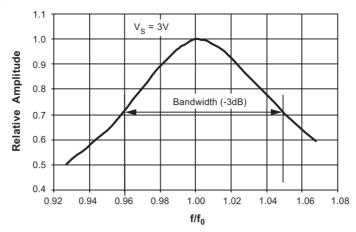


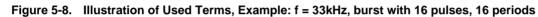
Figure 5-6. Data Transmission Rate, $V_s = 5V$

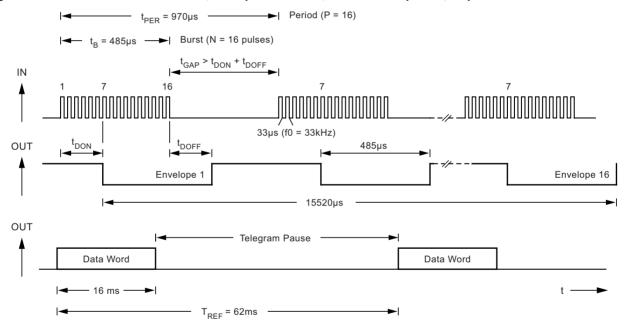




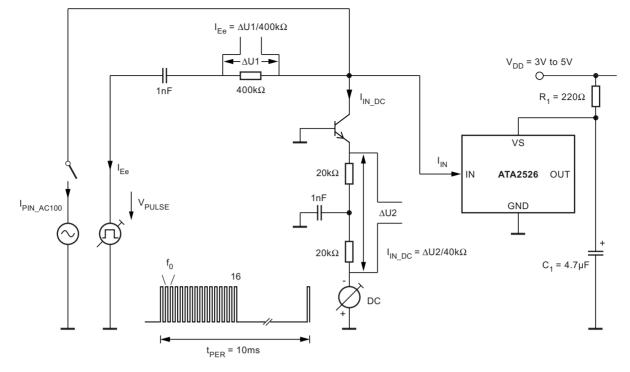


Q = f/f₀/B; B → -3dB values Example: Q = 1/(1.047 - 0.954) = 11

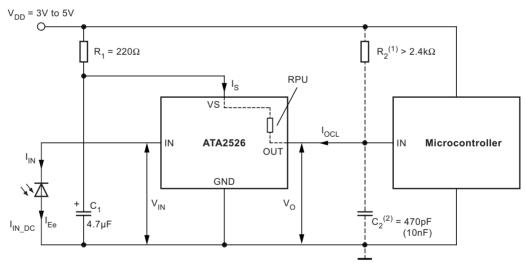








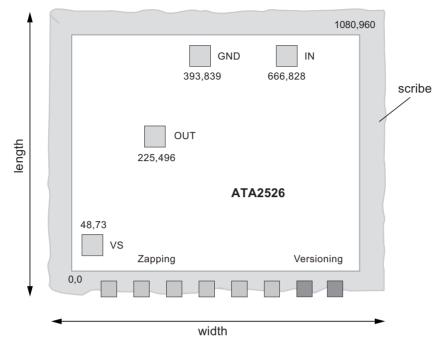




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6. Chip Dimensions

Figure 6-1. Chip Size in µm



Note: Pad coordinates are given for lower left corner of the pad in µm from the origin 0,0

Dimensions	Length inclusive scribe	1.04mm	
	Width inclusive scribe	1.20mm	
	Thickness	290µ ±5%	
	Pads	$80\mu\times80\mu$	
	Fusing pads	$60\mu\times60\mu$	
Pad metallurgy	Material	AlCu/AlSiTi ⁽¹⁾	
	Thickness	0.8µm	
Finish	Material	Si ₃ N ₄ /SiO ₂	
	Thickness	0.7/0.3µm	

Note: 1. Value depends on manufacture location.



7. Ordering Information

Delivery: unsawn wafers (DDW) in box

Extended Type Number	D ⁽²⁾	Туре
ATA2526S1xx ⁽¹⁾ C-DDW	2175	Standard type: ≥ 10 pulses, high data rate
ATA2526S3xx ⁽¹⁾ C-DDW	1400	Lamp type: \geq 10 pulses, enhanced suppression of disturbances, secure data transmission
ATA2526S7xx ⁽¹⁾ C-DDW	3415	Short burst type: ≥ 6 pulses, highest data rate

Notes: 1. xx means carrier frequency value (33, 36, 37, 38 or 40kHz and 56kHz)

2. Maximum data transmission rate up to bits/s with $f_0 = 56$ kHz, $V_S = 5V$ (see Figure 5-6 on page 7)

7.1 Pad Layout

Figure 7-1. Pad Layout

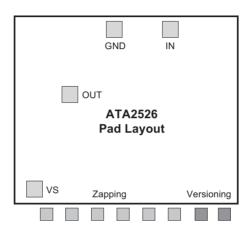


Table 7-1. Pin Description

Symbol	Function
OUT	Data output
VS	Supply voltage
GND	GND
IN	Input pin diode
Zapping	f ₀ adjust
Versioning	Type adjust

8. Revision History

Please note that the following page numbers referred to in this section refer to the specific revision mentioned, not to this document.

Revision No.	History
4905G-AUTO-04/14	Put datasheet in the latest template
4905F-AUTO-05/10	Thermal Resistance table deleted
49051-2010-03/10	 Pin columns in Electrical Characteristics tables deleted
4905E-AUTO-09/09	Put datasheet in newest template
4905E-A010-09/09	 Section 8 "Ordering Information" on page 12 changed
	Features on page 1 changed
	Applications on page 1 changed
	 Section 1 "Description" on page 1 changed
	 Section 2 "Pin Configuration" on page 2 changed
4905D-AUTO-10/06	 Number 2.2, 3.3 and 3.4 of Section 5 "Electrical Characteristics, 3-V Operation" on pages 3 to 4 changed
49030-A010-10/06	Number 73, 7.4 and 8.4 of Section 5 "Electrical Characteristics, 3-V Operation" on page 5 to 6 changed
	Section 6.1 "ESD" on page 6 deleted
	 Figure 7-10 "Application Circuit" on page 10 changed
	 Section 9 "Ordering Information" on page 12 changed
	Rename Figure 9-1 on page 12
4905C-AUTO-04/06	Section 9 "Ordering Information" on page 12 changed
4905B-AUTO-04/06	Put datasheet in a new template
4900D-AUTO-04/00	Section 8 "Chip Dimensions" on page 11 changed



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